

RoHS

COMPLIANT

N-Channel 30 V (D-S) MOSFET

Top View

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) Typ.	I _D (A)	Q _g (Typ.)			
30	0.004 at V _{GS} = 4.5 V	60	33.5 nC			
30	0.005 at V_{GS} = 2.5 V	50	33.3110			

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- •
- 100 % R_g and UIS Tested Compliant to RoHS Directive 2002/95/EC •

APPLICATIONS

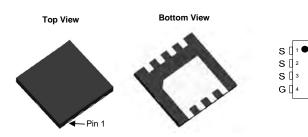
- Motor Control
- Industrial
- Load Switch
- ORing

8 D

7 D

6 D

5 D



DFN 3x3 EP



N-Channel MOSFET

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ABSOLUTE MAXIMUM RATIN	IGS (T _A = 25 °C	, unless othe	erwise noted)		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current (T _J = 150 °C)		I _D	60 ^{a, e} 40 ^{a, e} 22 ^{b, c} 15 ^{b, c}		
Pulsed Drain Current (t = 300 µs)		I _{DM}	150	A	
Continuous Source-Drain Diode Current	T _C = 25 °C T _A = 25 °C	۱ _S	35 3.3 ^{b, c}		
Single Pulse Avalanche Current Single Pulse Avalanche Energy		I _{AS}	20		
		E _{AS}	20	mJ	
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$ $T_{C} = 70 \text{ °C}$ $T_{A} = 25 \text{ °C}$ $T_{A} = 70 \text{ °C}$		P _D	52 33 3.7 ^{b, c} 2.4 ^{b, c}	w	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temper		260	Ŭ		

THERMAL RESISTANCE BATINGS

Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	24	33	°C/W	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.9	2.4	C/W	

Notes:

a. Based on $T_C = 25 \text{ °C}$. b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 90 °C/W. e. Calculated based on maximum junction temperature. Package limitation current is 80 A.

服务热线:400-655-8788

SPECIFICATIONS (T _{.1} = 25 °C,	unless othe	erwise noted)				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	-					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	L 050 A		30		24/20
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5.6		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.5		1.5	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zara Cata Valtaga Drain Current	1	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 °C			10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, V_{GS} = 10 V	30			A
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		0.0040		Ω
	US(on)	$V_{GS} = 2.5 V, I_{D} = 7 A$		0.0050		52
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		65		S
Dynamic ^b						
Input Capacitance	C _{iss}			6000		pF
Output Capacitance	C _{oss}	$V_{DS} = 15 V$, $V_{GS} = 0 V$, f = 1 MHz		406		
Reverse Transfer Capacitance	C _{rss}			360		
Total Gate Charge	Qg	$V_{DS} = 15$ V, $V_{GS} = 10$ V, $I_{D} = 10$ A		68	102	nC
				33.5	51	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		7.7		
Gate-Drain Charge	Q _{gd}			13.8		
Gate Resistance	Rg	f = 1 MHz	0.3	0.7	1.4	Ω
Turn-On Delay Time	t _{d(on)}			24	45	-
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω $I_D \cong$ 10 A, V_{GEN} = 4.5 V, R_a = 1 Ω		24	45	_
Turn-Off Delay Time	t _{d(off)}	$I_D = 10 \text{ A}, V_{GEN} = 4.3 \text{ V}, \Pi_g = 1.22$		32	60	
Fall Time	t _f			12	24	ns
Turn-On Delay Time	t _{d(on)}			14	28	-
Rise Time	t _r	V_{DD} = 15 V, R_L = 1.5 Ω $I_D \cong$ 10 A, V_{GEN} = 10 V, R_q = 1 Ω		13	26	
Turn-Off Delay Time	t _{d(off)}	$I_D = 10 \text{ A}, V_{GEN} = 10 \text{ V}, H_g = 1.52$		33	60	
Fall Time	t _f			8	16	
Drain-Source Body Diode Characteristic		T 05 %C	[05	[T
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C		35		A
Pulse Diode Forward Current	I _{SM}			70		
Body Diode Voltage	V _{SD}	I _S = 3 A, V _{GS} = 0 V		0.7	1.1	V
Body Diode Reverse Recovery Time	t _{rr}			21	40	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \ ^\circ\text{C}$		10	20	nC
Reverse Recovery Fall Time	t _a			9		ns
Reverse Recovery Rise Time	t _b			12		

Notes:

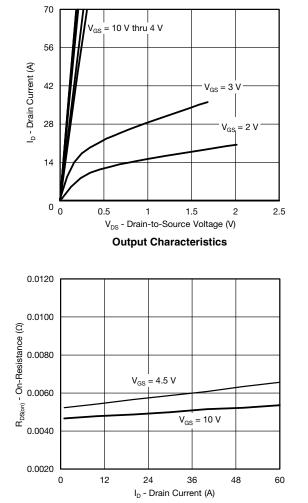
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 % b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

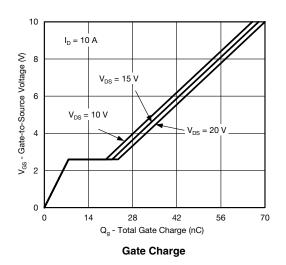
emi

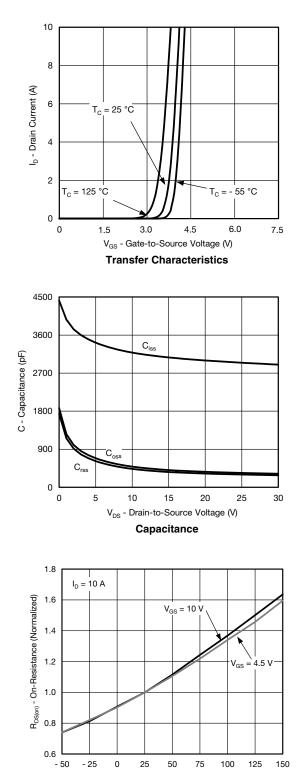
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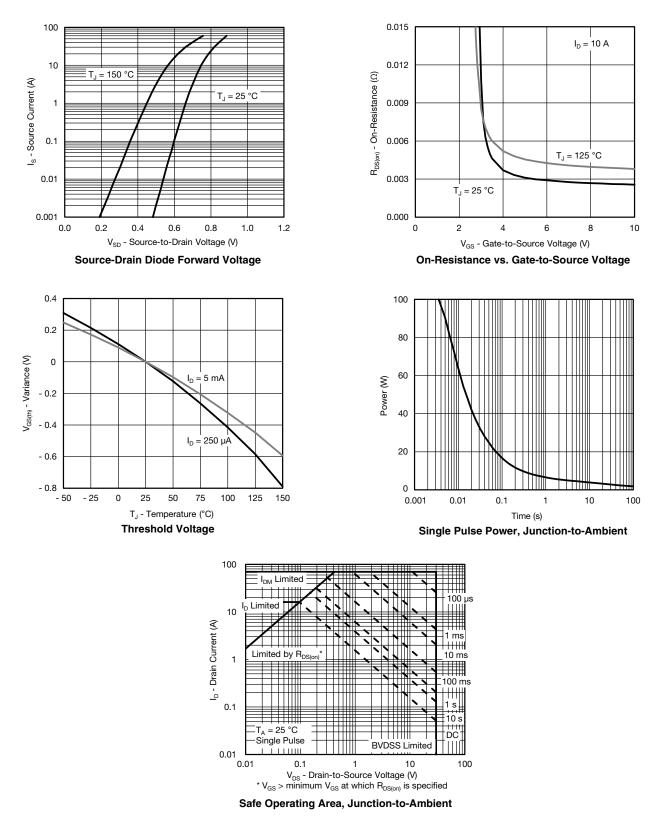
On-Resistance vs. Drain Current and Gate Voltage



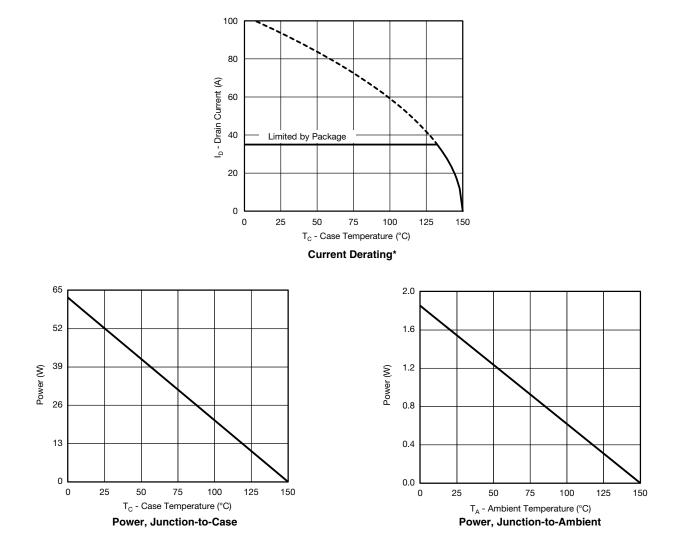


T_J - Junction Temperature (°C) On-Resistance vs. Junction Temperature



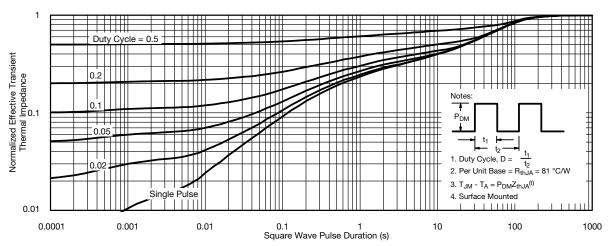


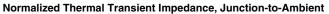


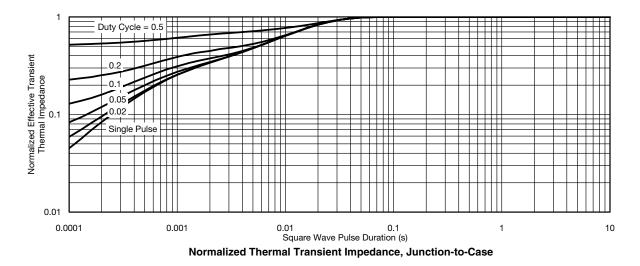


* The power dissipation P_D is based on $T_{J(max.)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

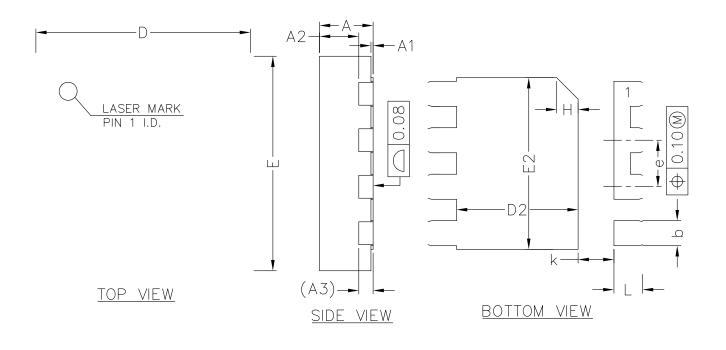








BSZ035N03MS G





<u>SIDE VIEW</u>

SYMBOL	MIN	NOM	МАХ	
А	0.70	0.75	0.80	
A1	0.00	0.02	0.05	
A2	0.50	0.55	0.60	
A3	0.20REF			
b	0.30	0.35	0.40	
D	2.90	3.00	3.10	
E	2.90	3.00	3.10	
D2	1.60	1.70	1.80	
E2	2.30	2.40	2.50	
е	0.55	0.65	0.75	
K	0.40	0.50	0.60	
L	0.35	0.40	0.45	

COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)





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